

ESRF OPTICAL METROLOGY APPLIED TO BENDABLE OPTICAL SURFACES

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<u>Outline</u>

- Overview of 15 years of metrology at the ESRF
- ***** ESRF small bender devices
- * New LTP measurement procedures and calculation methods
- ***** Last KB systems for Nano-focusing applications:

*****Bender technology

*****Fixed curvature mirrors

***** Conclusion





ESRF Long mirrors : length ≥ 400 mm







ESRF Long Mirrors quality evolution





Micro-roughness Wyko (10X) /Micromap (5X-50X)



Best of slope error:

0.3 μ rad / 900 mm - Silicon Mirror size 1200x100x60 mm but micro-roughness \approx 3Å rms

Best of micro-roughness:

0.6 Å - Silicon mirror Mirror size 700x60x27 mm but slope error $\approx 2 \ \mu rad rms$



LTP characterization of Long mirror benders







- 1. Mirror intrinsic slope error characterization (out of bender)
- 2. Mirror clamped on mechanics:
 - Evaluation of deformation induced by mechanics and correction if possible
 - Adjustment, optimization of gravity compensators
 - Verifying safety switches, range of curvature
- 3. Hysteresis cycles
- 4. Long term stability





Refurbishment: ID24 beamline Energy dispersive/X-ray Absorption Spectroscopy (ED-XAS)





VFM1 (1995) :graphite +SiC- flat



VFM1 (2004): Silicon - flat



Residual heights to best sphere







Refurbishment: ID24 beamline Energy dispersive/X-ray Absorption Spectroscopy (ED-XAS)



1995 : 50 μm x 110 μm **2006 : 2 μm x 5 μm** Significant spot size FWHM improvement !



"Energy-dispersive absorption spectroscopy for hard-X-ray micro-XAS applications", S. Pascarelli et al., J. Synchrotron Rad. (2006). 13, 351–358



Kirkpatrick-Baez systems at ESRF





KB development at ESRF

Since 2001: 61 benders tested and pre-shaped at the metrology lab 22 with multilayer coatings



2001 2002 2003 2004 2005 2006 2007 2008

Different configurations:

- Single bender (13)
 - ► KB 170-170 (8)
 - ► KB 170-96 (8)
 - ► KB 170-300 (3)
 - ► KB 300-300 (5)



Spot size		
ID23	5 x 7 µm	
ID27	2 x 4 µm	
ID13	0.3 x 0.4 µm	
ID22	76 x 84 nm	
ID19	45 nm in Vertical	
	Graded multilayer *	

Spot size achieved is generally close to geometrical limit (i.e. not limited by optics aberrations) * O.Hignette et al., AIP Conf Proc.- January 19, 2007 - Volume 879, pp. 792-795



Metrology for thermal stability studies on KB

ID08 example: UHV bender

 $\begin{array}{c} p=3 m \\ q=5 m \\ \Theta=28 \text{ mrad} \end{array} \right\} \quad \text{Rc} = 137 \text{ m}$

Focused beam instability over 24 hours :

- spot position drift : >300 μm
- spot size increase: $70\mu m \rightarrow 500\mu m$ Ex-situ evaluation of bender to determine origins of instabilities



Software development for automated control of Fisba acquisitions



Setup with FISBA interferometer + 8 thermocouples



Setting high vacuum 2.10^{-8} mbar 6 days – baking up to 120° C

Monitoring Rc and temperature:

- 2.5 days to return to room temperature
- Mirror relaxing : 50 m (Rc=191m)



Time to reach stability defined



ESRF KB technology improvements

✓ Mirror clamping: significant improvement of the interface mirror/mechanics



✓ Mirror width profile optimization mandatory for strong aspherizations





Quality highly dependent on optics

New generation of hard X-ray mirrors used in KB configuration:

- Short focal distance (tens of mm)
- Strong radius of curvature variation along meridian
- Shape error better than 1 nm P-V

Development of manufacturing techniques:

- Ion Beam Figuring (ZEISS, REOSC, ESRF...)
- Magneto-rheological finishing (SESO...)
- Differential coating (APS, Osaka University)
- Computer controlled optical surfacing (Tinsley Corp. ...)
- Elastic Emission Machining (Osaka University- JTEC)

These techniques of deterministic surface correction require accurate metrology.



Measurement procedures : ESRF LTP stitching method

The idea is to split the scan line AB in short scans overlapped with:

- 1. small <u>and</u> constant angular deviation for each of them
- 2. constant spatial overlap

Before each scan, the mirror is tilted to reproduce similar LTP beam path over optical components. Mirror slope profile is reconstructed by stitching all scans together.



This procedure fully automated is quite fast



Illustration of ESRF LTP stitching results

Mirror : SN1 provided by APS for the second 3big-RR Design parameters: p=60 m, q=60 mm, $\theta=3 \text{ mrad}$



Slope error = $0.26 \mu rad rms$ Shape error = 0.42 nm rms





• Agreement better than 0.5 nm peak to peak with micro-stitching interferometry result



Ellipse analytical description

Round-Robin on aspheric optics: APS/ SPring-8 / ESRF (SPIE Proc, vol. 6704, 2007)



In the (x,y) coordinates system the equation of the ellipse figure is given by:

$$y(x) = -\cos\mu \times \left[\sqrt{b^2 - b^2} \times \left(\frac{x\cos\mu + x_0}{a}\right)^2 - y_0\right] + x \times \cos\mu \times \sin(-\mu)$$

 x_0, y_0 : coordinates of mirror center / ellipse center μ : slope at the center of mirror in u,v coordinate system

Theoretical slope of ellipse is the derivative of ellipse figure equation

Optimization of \mathbf{q} and $\mathbf{\Theta}$ to minimize the RMS of residual slopes is necessary whereas slope errors are dominated by defocus !



Errors related to polynomial approximation

For large radius of curvature, approximation by a polynomial is acceptable But not for strongly curved surfaces







4th order : valid on 20% of length 10th order: valid on 50% of length



Precision required on mirror coordinates

 Center of mirror definition: LTP encoder + fringe pattern detection repeatability achieved ± 6 microns

Mirror coordinates are equally interleaved Values are rounded to a tenth of mm (can get better with encoder feedback but not used up to now!)

What is the consequence of an uncertainty in the determination of X mirror coordinates of the order of a tenth of a micron ?

Rc ≈20 m

 $\frac{\text{Numerical example}}{q=0.06 \text{ m}} \left. \begin{array}{c} p=59.5 \text{ m} \\ q=0.06 \text{ m} \\ \Theta=6 \text{ mrad} \end{array} \right\}$

Starting from an LTP measurement with a sampling step of 0.5 mm

- •X position array rounded to tenth of mm
- •Slope array

Now, random noise is added to mirror coordinates array

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Precision required on mirror coordinates

Random noise added to mirror coordinates array amplitude ± 6 microns Applied 10 times



Discrepancy: up to 1 nanometer peak to peak !





focal distance : 45μ m Incidence angle : 6μ rad Ratio p/q = constant



Nano-focusing: ESRF 'state of the art' KB system

Compact Dynamic KB ID13 Microfocus



Spot size goal : 200nm x 200nm

- Flex arm bender design
- Width profiled mirrors
 VF Shape error rms : 3.2 nm rms
 HF Shape error rms : 6.9 nm rms
- Bonding optics technology
- All invar construction
- Online orthogonality adjustment

High flux measured : 10¹¹photons Stable curvature over several days

Spot size achieved : 300nm x 250nm Due to non-optimal mirror profile...



Compact Dynamic KB : Mirror profile width influence

Horizontal Focusing Mirror : 3 different width profile tested









LC mirror

Ellipse parameters: p =98m, q=80mm and θ =4.4 mrad

scan length (mm)	slope error rms / best ellipse	shape error rms / best ellipse
50 mm	1.4 µrad	6.9 nm
40 mm	0.35 µrad	1.4 nm

Optimal width not achieved:

- manufacturing errors ?
- bad model ?





Nano-focusing: ESRF 'state of the art' KB system





Spot size goal : 200nm x 200nm

- 110mm / 60mm IBF optics (ZEISS)
- 2/3 IBF iterations: roughness < 3Å

Shape error RMS evolution



- All invar construction
- UHV Picomotors
- Invar body capacitive sensors



Ion Beam Figuring at ESRF





Summary

- Long mirror optical surface quality has been really improved over 15 years
- Micro-roughness still limited above 1Å rms for flat mirrors and higher values for cylinders
- ➢ Today, KB development at ESRF is oriented towards nano-focusing needs with particular emphasis on stability issues.
- > Due to compacity criteria, new approaches of KB are investigated:
 - bonded technology in dynamic KB
 - ➢ fixed curvature mirrors prefigured by IBF or differential coating (APS-ESRF)
- > Optical metrology has also been improved:
 - >development of LTP measurement procedures
 - ➢Round-Robin activity
- > Metrology plays a key role in all these developments.



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